



SPECIFICATION FOR LED LAMP

PART NO. : LT33B1-81-UAC2-ECL

10mm ROUND TYPE

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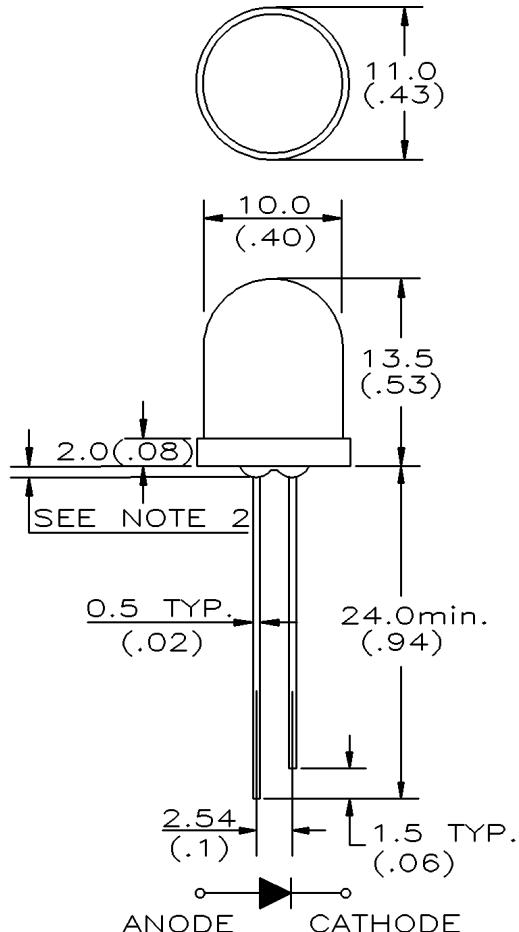
Features

- * High intensity
- * Reliable and rugged
- * Low current requirement
- * IC compatible

Description

The blue lamps are made with InGaN chips and blue diffused epoxy resin.

Package Dimensions



Notes :

1. All dimensions are in millimeters (inches).
2. Protruded resin under flange is 1.0mm (.04") max.
3. Tolerance is $\pm 0.25\text{mm}$ (0.01") unless otherwise noted.

| Part No. | Led Chip | | Lens Color |
|--------------------|----------|----------------|---------------|
| | Material | Emitting Color | |
| LT33B1-81-UAC2-ECL | InGaN | Blue | Blue Diffused |



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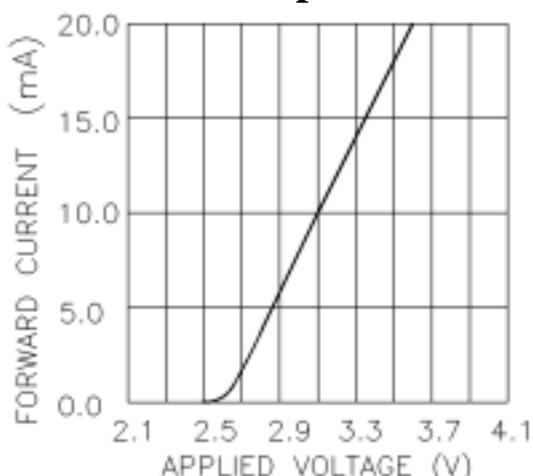
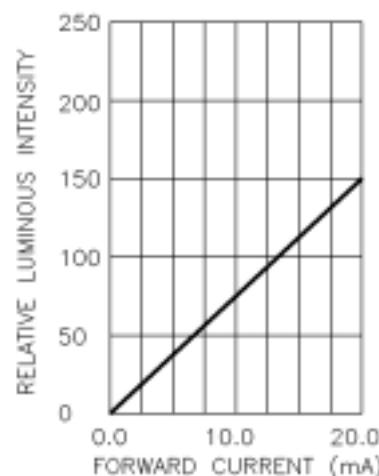
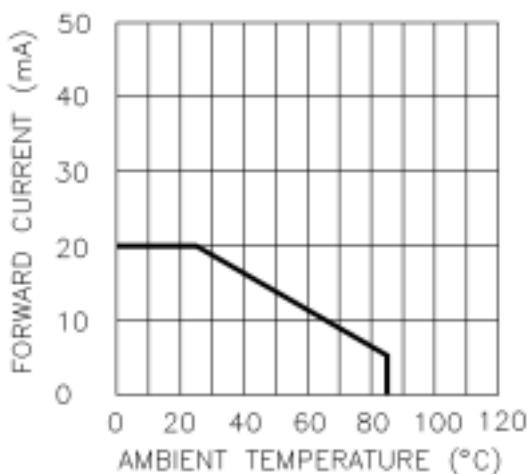
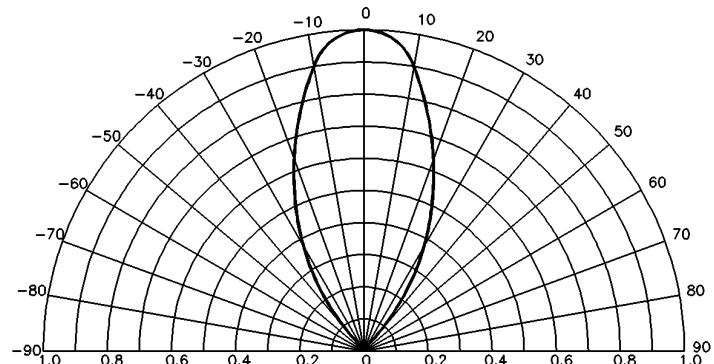
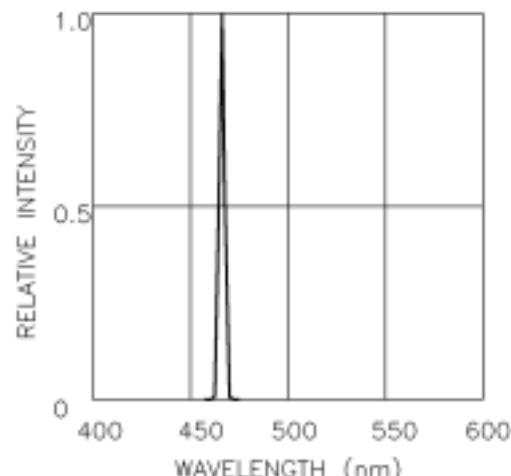
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Absolute Maximum Ratings at Ta=25°C :

| Parameter | Symbol | Rating | Unit |
|--|-----------|-------------|------|
| Power Dissipation | Pd | 80 | mW |
| Reverse Voltage | Vr | 5 | V |
| D.C. Forward Current | If | 20 | mA |
| Peak Current (1/10 Duty Cycle,0.1ms pulse width) | If (Peak) | 100 | mA |
| Operating Temperature Range | Topr | -25 to +85 | °C |
| Storage Temperature Range | Tstg | -40 to +100 | °C |
| Lead Soldering Temp. (1.6mm from body) for 5 seconds | | 260 | °C |
| Electric Static Discharge Threshold (HBM) | | 1000 | V |

Electrical and Optical Characteristics :

| Parameter | Symbol | Condition | Min. | Typ. | Max. | Unit |
|---------------------|-----------------|-----------|------|------|------|---------|
| Luminous Intensity | Iv | If=20mA | 90 | 150 | | mcd |
| Forward Voltage | Vf | If=20mA | | 3.6 | 4.0 | V |
| Dominant Wavelength | λ_d | If=20mA | | 470 | | nm |
| Reverse Current | Ir | Vr=5V | | | 50 | μA |
| Viewing Angle | $2\theta_{1/2}$ | If=20mA | | 50 | | deg |

Typical Electrical / Optical Characteristics Curves :**Forward Current vs. Forward Voltage****Forward Current vs.
Relative Luminous Intensity****Ambient Temperature vs. Forward Current****Radiation Diagram****Relative Intensity vs. Wavelength**



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Reliability Test Method :

| Test Item | Test Condition | Duration Time |
|---|-------------------------------|---------------|
| Operation Life | If=20mA / Ta=25°C | 168 hrs |
| Storage at High Temperature | Ta=100°C | 168 hrs |
| Storage at Low Temperature | Ta=-40°C | 168 hrs |
| Storage at High Temperature/High Humidity | Ta=85°C / RH=85% | 168 hrs |
| Operating at High Temperature | Ta=85°C / If=20mA | 168 hrs |
| Operating at Low Temperature | Ta=-25°C / If=20mA | 168 hrs |
| Thermal Shock | Ta/T=100°C/30min~ -40°C/30min | 10 cycles |
| Solderability | Tsol=260°C | 5 sec |

Criteria for Judging The Damage :

| Item | Symbol | Test Condition | Criteria for Judgment | |
|--------------------|--------|----------------|-----------------------|-------------------|
| | | | Min. | Max. |
| Forward Voltage | Vf | If=20mA | — — — | Initial Data x1.1 |
| Reverse Current | Ir | Vr=5V | — — — | 50 μA |
| Luminous Intensity | Iv | If=20mA | Initial Data x0.8 | — — — |

Precautions :

If the lead is formed, the lead should be formed up to 5mm from the body of the device without forming stress to the resin. Soldering should be performed after lead forming.